

Section _____

HV Semi-conductor

Application _____

Field
Laboratory
Production



PRODUCT BENEFITS

Low roughness over insulation once bonded semiconductor removed
Performs a large chamfer on the transition from semiconductor to insulation
Quick set up on tools AMF4 and AMF5 thanks to push-button

TOOL CAPACITY

Diameter 55 - 160 mm
2,165 - 6,299 inch

TOOL DIMENSIONS

Length 0 mm

Width 0 mm

Height 0 mm

Weight without box 0 Kg

Packaging None

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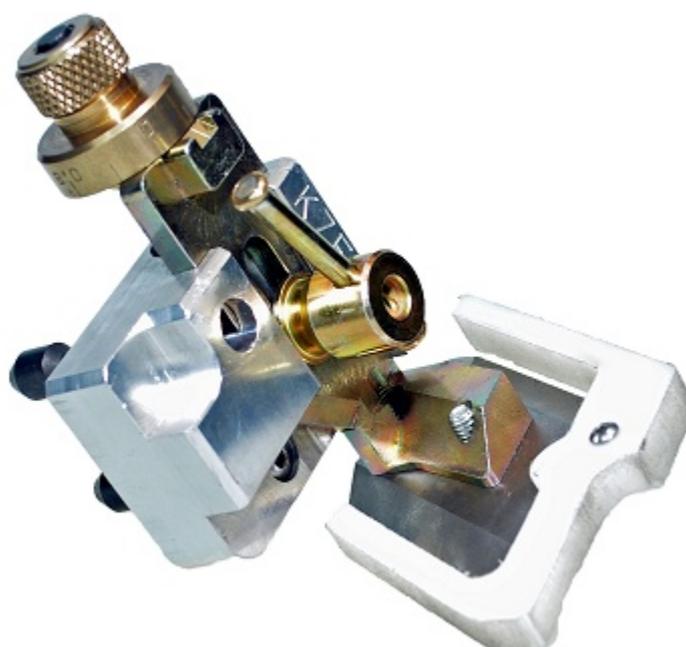
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www.alroc.fr

Blade support with blade LFNS for bonded semiconductor. To be mounted on tools series AMF4 and AMF5

TO DO WHAT

The K7/FNS is to be mounted on tools Alroc series AMF4 and AMF5 to remove bonded semiconductor on HV cables



Spare part

LFNS - Spare blade for bonded semiconductor

Associated tool

K7/INS - Blade support with blade LINS for insulation (for tools series AMF5)

K7/PNS - Blade support to make groove into the insulation

K7/GNS - Blade support with black protection for the outer sheath's semiconductive layer

HV cables Tools
K7/FNS



| Part Number | Diameter | Tool capacity | Dimensions | | | Packaging |
|---------------|---------------------------------|---------------|------------------|------------------|------------------|-----------|
| | | | Length | Width | Height | |
| K7/FNS | 55 - 160 mm 2,165 - 6,299 in | | 0 mm 0,000 in | 0 mm 0,000 in | 0 mm 0,000 in | none |